

UT54ACS132/UT54ACTS132

Quadruple 2-Input NAND Schmitt Triggers

Datasheet

November 2010

www.aeroflex.com/logic



FEATURES

- ❑ 1.2 μ CMOS (ACTS 132) and 0.6 μ CRH CMOS process (ACS132)
 - Latchup immune
- ❑ High speed
- ❑ Low power consumption
- ❑ Single 5 volt supply
- ❑ Available QML Q or V processes
- ❑ Flexible package
 - 14-pin DIP (not available for the ACS132)
 - 14-lead flatpack
- ❑ UT54ACS132 - SMD 5962-96542
- ❑ UT54ACTS132 - SMD 5962-96543

DESCRIPTION

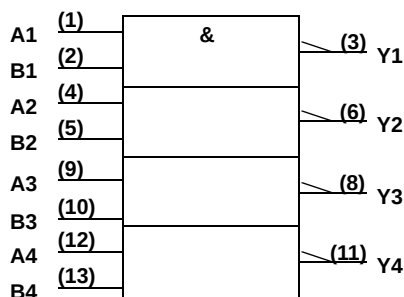
The UT54ACS132 and the UT54ACTS132 are 2-input NAND gates with Schmitt Trigger input levels. A high applied on both the inputs forces the output to a low state.

The devices are characterized over full military temperature range of -55°C to +125°C.

FUNCTION TABLE

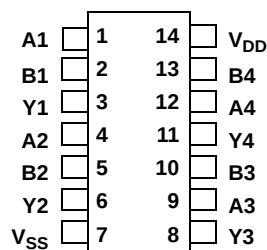
INPUTS		OUTPUT
A _n	B _n	Y _n
L	L	H
L	H	H
H	L	H
H	H	L

LOGIC SYMBOL

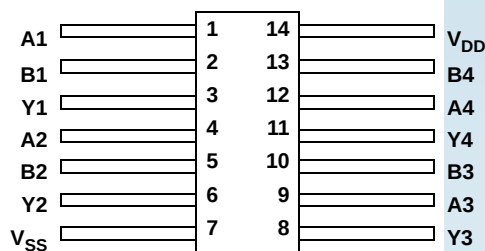


PINOUTS

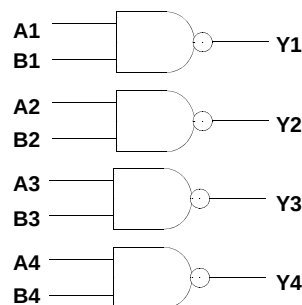
14-Pin DIP Top View



14-Lead Flatpack Top View



LOGIC DIAGRAM



Note:

1. Logic symbol in accordance with ANSI/IEEE standard 91-1984 and IEC Publication 617-12.

OPERATIONAL ENVIRONMENT¹

PARAMETER	LIMIT	UNITS
Total Dose	1.0E6 (ACTS132) 5.0E5 (ACS132)	rads(Si)
SEU Threshold ²	80	MeV-cm ² /mg
SEL Threshold	120	MeV-cm ² /mg
Neutron Fluence	1.0E14	n/cm ²

Notes:

1. Logic will not latchup during radiation exposure within the limits defined in the table.
2. Device storage elements are immune to SEU affects.

ABSOLUTE MAXIMUM RATINGS

SYMBOL	PARAMETER	LIMIT	UNITS
V _{DD}	Supply voltage	-0.3 to 7.0	V
V _{I/O}	Voltage any pin	-.3 to V _{DD} +.3	V
T _{STG}	Storage Temperature range	-65 to +150	°C
T _J	Maximum junction temperature	+175	°C
T _{LS}	Lead temperature (soldering 5 seconds)	+300	°C
Θ _{JC}	Thermal resistance junction to case	20	°C/W
I _I	DC input current	±10	mA
P _D	Maximum power dissipation	1	W

Note:

1. Stresses outside the listed absolute maximum ratings may cause permanent damage to the device. This is a stress rating only, functional operation of the device at these or any other conditions beyond limits indicated in the operational sections is not recommended. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIMIT	UNITS
V _{DD}	Supply voltage	4.5 to 5.5	V
V _{IN}	Input voltage any pin	0 to V _{DD}	V
T _C	Temperature range	-55 to + 125	°C

DC ELECTRICAL CHARACTERISTICS ⁷(V_{DD} = 5.0V ±10%; V_{SS} = 0V ⁶, -55°C < T_C < +125°C); Unless otherwise noted, T_C is per the temperature range ordered.

SYMBOL	PARAMETER	CONDITION	MIN	MAX	UNIT
V _T ⁺	Schmitt Trigger, positive going ¹ threshold ACTS ACS			2.25 .7V _{DD}	V
V _T ⁻	Schmitt Trigger, negative going ¹ threshold ACTS ACS		0.5 .3V _{DD}		V
V _H	Schmitt Trigger, typical range of hysteresis ² ACTS ACS		0.3 0.6	0.9 1.5	V
I _{IN}	Input leakage current ACTS/ACS	V _{IN} = V _{DD} or V _{SS}	-1	1	μA
V _{OL}	Low-level output voltage ³ ACTS ACS	I _{OL} = 8.0mA I _{OL} = 100μA		0.40 0.25	V
V _{OH}	High-level output voltage ³ ACTS ACS	I _{OH} = -8.0mA I _{OH} = -100μA	.7V _{DD} V _{DD} - 0.25		V
I _{OS}	Short-circuit output current ^{2,4} ACTS/ACS	V _O = V _{DD} and V _{SS}	-200	200	mA
I _{OL}	Output current ¹⁰ (Sink)	V _{IN} = V _{DD} or V _{SS} V _{OL} = 0.4V	8		mA
I _{OH}	Output current ¹⁰ (Source)	V _{IN} = V _{DD} or V _{SS} V _{OH} = V _{DD} - 0.4V	-8		mA
P _{total}	Power dissipation ^{2, 8, 9}	C _L = 50pF		1.9	mW/ MHz
I _{DDQ}	Quiescent Supply Current	V _{DD} = 5.5V		10	μA
ΔI _{DDQ}	Quiescent Supply Current Delta ACTS	For input under test V _{IN} = V _{DD} - 2.1V For all other inputs V _{IN} = V _{DD} or V _{SS} V _{DD} = 5.5V		3.1	mA
C _{IN}	Input capacitance ⁵	f = 1MHz @ 0V		15	pF
C _{OUT}	Output capacitance ⁵	f = 1MHz @ 0V		15	pF

Notes:

1. Functional tests are conducted in accordance with MIL-STD-883 with the following input test conditions: $V_{IH} = V_{IH(min)} + 20\%$, $- 0\%$; $V_{IL} = V_{IL(max)} + 0\%$, $- 50\%$, as specified herein, for TTL, CMOS, or Schmitt compatible inputs. Devices may be tested using any input voltage within the above specified range, but are guaranteed to $V_{IH(min)}$ and $V_{IL(max)}$.
2. Supplied as a design limit but not guaranteed or tested.
3. Per MIL-PRF-38535, for current density $\leq 5.0E5$ amps/cm², the maximum product of load capacitance (per output buffer) times frequency should not exceed 3,765 pF/MHz.
4. Not more than one output may be shorted at a time for maximum duration of one second.
5. Capacitance measured for initial qualification and when design changes may affect the value. Capacitance is measured between the designated terminal and V_{SS} at frequency of 1MHz and a signal amplitude of 50mV rms maximum.
6. Maximum allowable relative shift equals 50mV.
7. All ACTS specifications are valid for radiation dose $\leq 1E6$ rads(Si), and all ACS specifications are valid for radiation dose $\leq 5E5$ rads(Si).
8. Power does not include power contribution of any TTL output sink current.
9. Power dissipation specified per switching output.
10. This value is guaranteed based on characterization data, but not tested.

AC ELECTRICAL CHARACTERISTICS ²

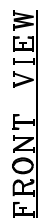
($V_{DD} = 5.0V \pm 10\%$; $V_{SS} = 0V$ ¹, $-55^{\circ}C < T_C < +125^{\circ}C$); Unless otherwise noted, Tc is per the temperature range ordered.

SYMBOL	PARAMETER	MINIMUM	MAXIMUM	UNIT
t_{PHL}	Input to Yn	2	15	ns
t_{PLH}	Input to Yn	2	12	ns

Notes:

1. Maximum allowable relative shift equals 50mV.
2. For the ACTS version, all specifications are valid for radiation dose $\leq 1E6$ rads(Si). For the ACS version, all specifications are valid for radiation dose $\leq 5E5$ rads(Si).

Side-Brazed Packages



PKG CONFIG	LEAD COUNT	MIL-STD- 1835 DWG CONF C	DIMENSION SYMBOLS													
			A	b	b2	c	D	E	e	eA	L	Q	S1	S2	aaa	bbb
-01	14	D-1	0.200 -----	0.026 0.014	0.065 0.045	0.018 0.008	0.785 -----	0.310 0.220	0.100 BSC	0.300 BSC	0.200 0.125	0.060 0.015	----- 0.005	0.015 -----	0.030 -----	0.010 -----
-02	16	D-2	0.200 -----	0.026 0.014	0.065 0.045	0.018 0.008	0.840 -----	0.310 0.220	0.100 BSC	0.300 BSC	0.200 0.125	0.060 0.015	----- 0.005	0.015 -----	0.030 -----	0.010 -----
-03	20	D-8	0.200 -----	0.026 0.014	0.065 0.045	0.018 0.008	1.060 -----	0.310 0.220	0.100 BSC	0.300 BSC	0.200 0.125	0.070 0.015	----- 0.005	0.015 -----	0.030 -----	0.010 -----

Technical drawing of a multi-ported device, showing Top and Front views.

Top View:

- Overall dimensions: E_1 (width), E_2 (length), E_3 (height).
- Central rectangular area: E_1 (width), E_2 (length).
- Central ID mark: $\Phi 0.010 \text{ H/A-B } \textcircled{S} \text{ D } \textcircled{S}$.
- Port locations: $(N-2)$ PLACES, (N) PLACES, (4) PLACES S_1 , $(N-1)$ PLACES S_2 .
- Port dimensions: k (width), e (height), b (width), d (height).
- Port labels: $-A-$, $-B-$, $-C-$, $-D-$.
- Port specifications: $\Phi 0.036 \text{ M H/A-B } \textcircled{S} \text{ D } \textcircled{S}$.
- Port ID mark: PIN #1 ID MARK.

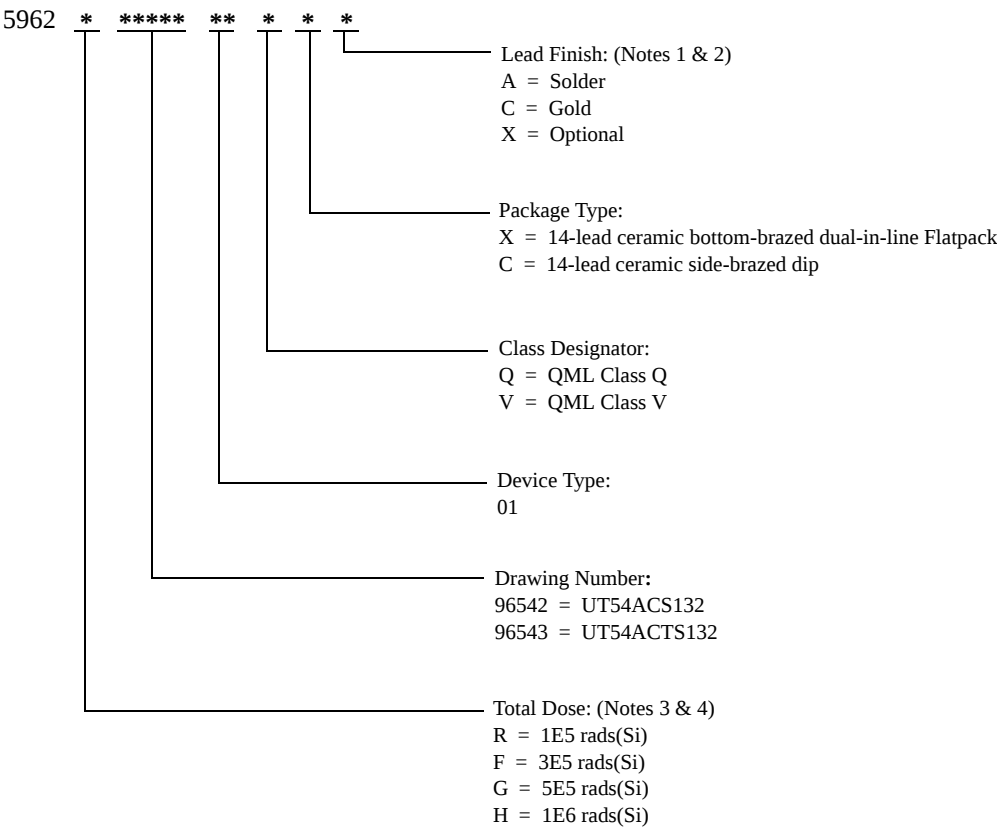
Front View:

- Overall dimensions: L (length), E (width), E_3 (height).
- Central rectangular area: L (length), E (width).
- Central ID mark: $\Phi 0.010 \text{ H/A-B } \textcircled{S} \text{ D } \textcircled{S}$.
- Port locations: $(N-2)$ PLACES, (N) PLACES, (4) PLACES S_1 , $(N-1)$ PLACES S_2 .
- Port dimensions: k (width), e (height), b (width), d (height).
- Port labels: $-A-$, $-B-$, $-C-$, $-D-$.
- Port specifications: $\Phi 0.036 \text{ M H/A-B } \textcircled{S} \text{ D } \textcircled{S}$.
- Port ID mark: PIN #1 ID MARK.

FRONT VIEW

PKG CONFIG	LEAD COUNT	MIL-STD 1835 DWG CONF B	DIMENSION SYMBOLS												
			A	b	c	D	E	E1	E2	E3	e	k	L	Q	S1
-03	14	F-2A	0.115	0.022	0.009	0.390	0.260	0.290	-----	-----	0.050	0.015	0.370	0.045	-----
			0.045	0.015	0.004	-----	0.235	-----	0.130	0.030	BSC	0.008	0.270	0.026	0.005
-04	16	F-5A	0.115	0.022	0.009	0.440	0.285	0.315	-----	-----	0.050	0.015	0.370	0.045	-----
			0.045	0.015	0.004	-----	0.245	-----	0.130	0.030	BSC	0.008	0.250	0.026	0.005
-05	20	F-9A	0.115	0.022	0.009	0.540	0.300	0.330	-----	-----	0.050	0.015	0.370	0.045	-----
			0.045	0.015	0.004	-----	0.245	-----	0.130	0.030	BSC	0.008	0.250	0.026	0.000

UT54ACS132/UT54ACTS132: SMD



- Notes:**
- 1. Lead finish (A,C, or X) must be specified.
 - 2. If an “X” is specified when ordering, part marking will match the lead finish and will be either “A” (solder) or “C” (gold).
 - 3. Total dose radiation must be specified when ordering. QML Q and QML V not available without radiation hardening. For prototype inquiries, contact factory.
 - 4. Device type 02 is only offered with a TID tolerance guarantee of 3E5 rads(Si) or 1E6 rads(Si) and is tested in accordance with MIL-STD-883 Test Method 1019 Condition A and section 3.11.2. Device type 03 is only offered with a TID tolerance guarantee of 1E5 rads(Si), 3E5 rads(Si), and 5E5 rads(Si), and is tested in accordance with MIL-STD-883 Test Method 1019 Condition A.

Aeroflex Colorado Springs - Datasheet Definition

Advanced Datasheet - Product In Development

Preliminary Datasheet - Shipping Prototype

Datasheet - Shipping QML & Reduced Hi-Rel

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